

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Expedited Handling
Response under 37 CFR § 1.116

| | | | |
|---|------------|----------------|-------------------------|
| Appln. Ser. No.: | Filed: | Inventor(s): | Atty Dkt: |
| 09/074,012 | 5 May 1998 | S. Yoshida | 114GI-121 (0694-121) |
| Title: Highly Heat-Conductive Composite Magnetic Body | | | |
| Examiner: B. Pianalto | | Art Unit: 1762 | |

Box AF
Asst. Comm'r for Patents
Washington, D.C. 20231-00014 Pages Total in Response **VIA FACSIMILE**
703-872-9311

RESPONSE AND AMENDMENT

Official

Dear Sir:

FAX RECEIVED

In connection with the final rejection of the claims of this application mailed 7 December 2001, a Notice of Appeal having been filed on 7 June 2002, please first amend the subject application as follows, the amendments being shown in marked up form in the attached appendix.

IN THE CLAIMS:

sub 1 > 10. (Thrice amended.) An electronic device comprising:
a stationary electromagnetic interference suppressing body for suppressing electromagnetic interference due to external and/or internal presence of electromagnetic waves, said stationary electromagnetic interference suppressing body comprising an organic binding agent layer and a soft magnetic powder dispersed through said organic binding agent layer and further comprising a heat conductive powder dispersed through said organic binding agent layer, for improving the thermal conductivity of said electromagnetic interference suppressing body during use therein in association with said electronic device.

09/074,012

Page 1 of 4

114GI-121